

APPROVAL SHEET

WLPH252012_P Series SMD Molded Power Inductor





*Contents in this sheet are subject to change without prior notice.

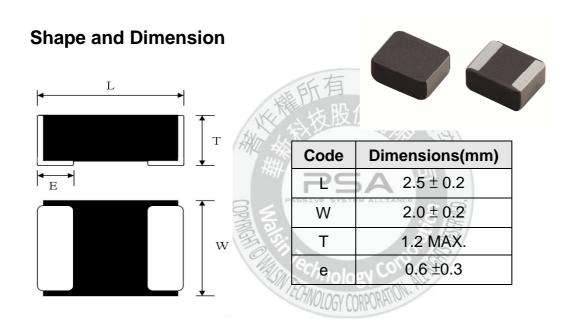


Features

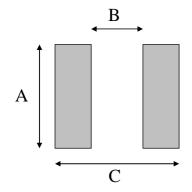
- 1. High saturation current realized by material properties and structure design
- 2. Low DC resistance to achieve high conversion efficiency and lower temperature rising
- 3. Low Profile: $2.5 \text{ mm} \times 2.0 \text{ mm} \times 1.2 \text{ mm}$.
- 4. Magnetically shielded structure to accomplish high resolution in EMC protection.
- 5. Halogen free, Lead Free, RoHS Compliance.

Applications

- 1. WLPH series is generic applied in portable DC to DC converter line.
- 2. Smart phone, PAD applications high current and low profile power supplier.
- 3. DC/DC converter
- 4. Thin-type power supply module,



Recommend Pattern



A	B	C
[mm]	[mm]	[mm]
2.0	1.2	2.8

(Unit: mm)



Ordering Information

WL	PH	2520	12	М	R24	Р	Р
Product Code	Series	Dimensions	Thickness	Tolerance	Value	Packing Code	
WL: Inductor	SMD molded power inductor.	2.5 * 2.0mm	1.2mm	M: ± 20%	R24=0.24uH 2R2=2.20uH	P=7" Reeled (Embossed tape)	General

Electrical Characteristics

WI PH252012 P series

Walsin Part Number		Tolerance (±%)	RDC DC Resistance (mΩ)	Isat[A] Saturation Current		Irms[A] Heat Rating Current	
			(Typ) Max	Тур	Max	Тур	Max
WLPH252012MR47PP	0.47	20	(21) 25	5.3	4.95	4.6	4.18
WLPH252012MR68PP	0.68	20	(29) 35	5	4.63	3.7	3.36
WLPH252012M1R0PP	1.0	20	(41) 49	4.4	4.04	3.5	3.18
WLPH252012M1R5PP	1.5	20	(64) 77	3.2	2.91	2.5	2.27
WLPH252012M2R2PP	2.2	20有	(85) 98	3	2.73	2.27	2.06
WLPH252012M3R3PP	3.3	20	125(150)	2.1	1.8	2	1.8
WLPH252012M4R7PP	4.7	20	(196) 235	1.9	1.58	1.61	1.4

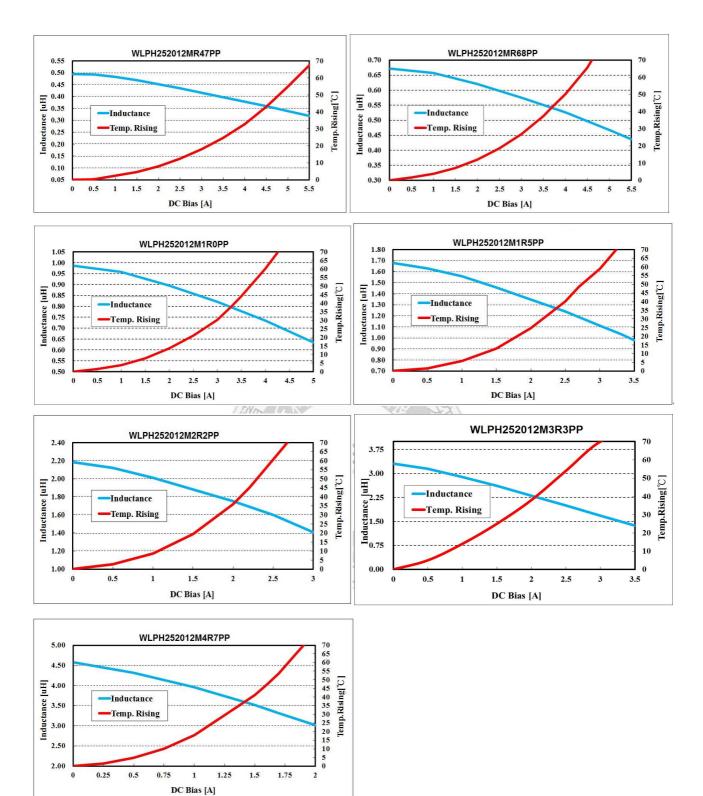
- 1: Customized design is available, please contact us.
- 2: All test referenced to 26°C ambient
- 3: Inductance is measured with Agilent[®] LCR meter 4285A (or equivalent) at 1MHz/1V.
- 4: DC resistance is measured with HIOKI® micro-ohm meter RM3542 or equivalent.
- 5: Isat means that DC current will cause a 30% inductance reduction from initial value.
- 6: Irms means that DC current will cause coil temp. rising to 40°C whichever is smaller.

Temperature Specifications

Operating Temperature range : -40° C to $+125^{\circ}$ C Storage Temperature range : -50° C to $+125^{\circ}$ C



Current Characteristic





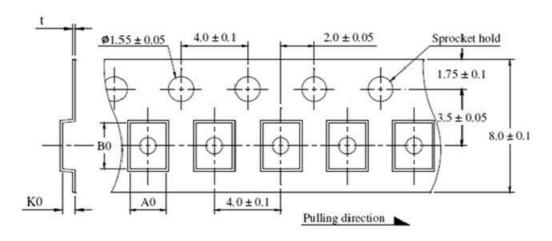
Reliability and Test Condition

Test item	Test condition	Criteria
Resistance to Solder Heat	 Solder temperature : 260 ± 5°C Flux : Rosin DIP time : 10 ± 1 sec 	 More than 95 % of terminal electrode should be covered with new solder No mechanical damage Inductance value should be within ± 20 % of the initial value
Adhesive Test	 Reflow temperature : 245℃ It shall be Soldered on the substrate applying direction parallel to the substrate Apply force(F) : 5 N Test time : 10 sec 	No mechanical damage Soldering the products on PCB after the pulling test force > 5 N
Temperature Cycle	 Temperature:-50 ~ 125°C For 30 minutes each Cycle: 500 cycles Measurement: At ambient temperature 24 hours after test completion 	No mechanical damage Inductance should be within ±20% of the initial value
Dry Heat Test	 Temperature: 85 ± 2°C Testing time: 500 hours Applied current: Full rated current Measurement: At ambient temperature hours after test completion 	No mechanical damage Inductance should be within ± of the initial value
Humidity Test	 Temperature: 60 ± 2°C Humidity: 90-95 % RH Applied current: Full rated current Testing time: 500 hours Measurement: At ambient temperature 24 hours after test completion 	No mechanical damage Inductance should be within ±20% of the initial value



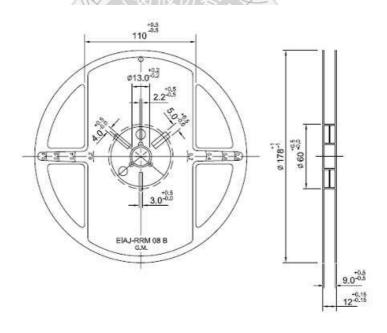
Taping Package and Label Marking

Carrier tape dimensions



	A0	B0	K0	t
mm	2.25±0.05	2.8±0.1	1.35±0.1	0.22±0.05

Taping reel dimensions



PART SIZE (EIA SIZE)	2520 (1008)
Qty.(pcs)	3,000
BOX	5 reels / inner box



Taping specifications

There shall be the portion having no product in both the head and the end of taping, and there shall be the cover tape in the head of taping.

Label Marking

The label specified as follows shall be put on the side of reel.

- (1) Part No
- (2) Quantity
- (3) Lot No
- * Part No. And Quantity shall be marked on outer packaging.

Quantity of products in the taping package

- (1)Standard quantity: 3000pcs/Reel
- (2) Shipping quantity is a multiple of standard quantity.

Precautions for Handling

Precaution for handling of substrate

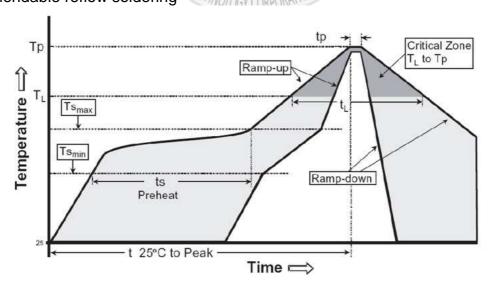
Do not exceed to bend the board after soldering this product extremely. (reference examples)

- Mounting place must be as far as possible from the position, which is close to the break line of board, or on the line of large holes of board.
- Do not bend extremely the board, in mounting another components. If necessary, use back-up pin (support pin) to prevent from bending extremely.
- Do not break the board by hand. We recommend to use the machine or the jig to break it.

Precaution for soldering

Note that this product will be easily damaged by rapid heating, rapid cooling or local heating. Do not give heat shock over 100°C in the process of soldering. We recommend to take preheating and gradual cooling.

Recommendable reflow soldering





Reference IPC-020c-5-1

Profile Feature	Pb free Assembly
Average Ramp Rate	3 ℃/second max
(Ts max to Tp)	
Preheat	
- Temperature Min (Ts _{min})	150℃
- Temperature Min (Ts _{max})	200℃
- Time(ts _{min} to ts _{min})	60-180 seconds
Time maintained above:	
- Temperature (TL)	217 ℃
- Time (tL)	60-150 seconds
Peak Temperature (T _p)	260℃ +0/-5 ℃
Time within 5 °C of actual Peak	20-40 seconds
Temperature (T _p)	
Ramp-Down Rate	6 °C/second max.
Time 25°C to Peak Temperature	8 minutes max

Soldering gun procedure

Note the follows, in case of using solder gun for replacement.

(1)The tip temperature must be less than 280°C for the period within 3 seconds by using soldering gun under 30 W.

(2) The soldering gun tip shall not touch this product directly.

Soldering volume

Note that excess of soldering volume will easily get crack the body of this product.

Taping Package Storage Condition

Storage Temperature : 5 to 40 $^{\circ}$ C Relative Humidity: < 65%RH Storage Time : 12 months max.